

**MT30001, Autumn 2016, IIT Kharagpur**

**Date on which the problems were given: 15 August 2016**

**Submit your assignment in the class of 22<sup>nd</sup> August 2016**

**Assignment 1:**

1.
  - a. What are the driving forces for each of the following: a) Recovery b) Recrystallization c) Grain growth?
  - b. What are the differences between recovery and grain growth?
  - c. What are the differences between cold working and hot working?
  - d. Why is recrystallization easy for a material undergone higher degree of cold working?
  
2.
  - a. How can you increase both strength and toughness (or, ductility) of a single phase polycrystalline material?
  - b. Write down and explain the governing equations for
    - i. Grain boundary strengthening.
    - ii. Solid solution strengthening
    - iii. Strain hardening
    - iv. Precipitation strengthening for an incoherent precipitate
  - c. What do you mean by crystallographic texture? State a method of forming crystallographic texture in a material.
  - d. Among the following pairs which one is stronger and why?
    - i. Single crystal vs. Poly crystal
    - ii. Pure metal vs. an alloy
    - iii. Single phase material vs. multi-phase material
    - iv. Fine distribution of incoherent precipitates and coarse distribution of incoherent precipitates (same volume fraction of precipitates)
    - v. Fine distribution of nano-sized coherent precipitates or coarse distribution of nano-sized coherent precipitates with same volume fraction of precipitates (assume particle shearing by dislocation is the deformation mechanism)
  
3. Consider a single crystal of silver oriented such that a tensile stress is applied along a  $[001]$  direction. If slip occurs on a  $(111)$  plane and in a  $[\bar{1}01]$  direction, and is initiated at an applied tensile stress of 1.1 MPa, compute the critical resolved shear stress.
  
4.
  - a. Write down one common Titanium alloy giving its composition. Where is it used?
  - b. Write down a few applications of Ti alloys.
  
5.
  - a. Write down a few techniques for fabrication of integrated circuits (IC).
  - b. Write down names of a few elemental and compound semiconductor materials.
  - c. Explain the structure of carbon nano-tube. State its applications.